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(54) **SOLAR PANEL**

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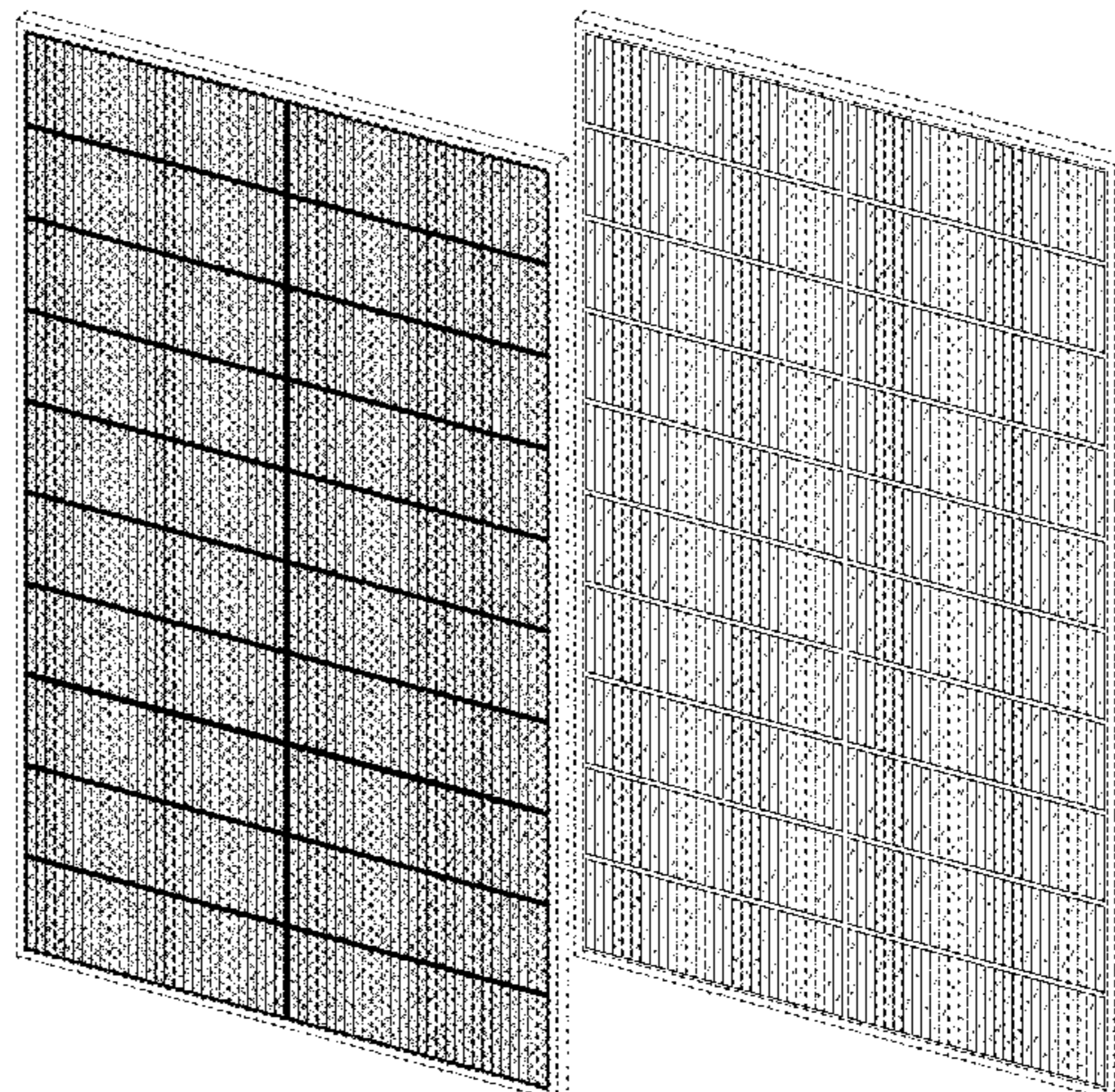
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(57)

CLAIM

The ornamental design for a solar panel, as shown and described.

DESCRIPTION

FIG. 1 is a front, top, and right side perspective view of a first embodiment of a solar panel;

FIG. 2 is a front elevational view thereof, the rear elevational view forming no part of the claimed design;

FIG. 3 is a top plan view thereof, the bottom plan view being a mirror image of the top plan view shown;

FIG. 4 is a left side elevational view thereof, the right side elevational view being a mirror image of the left side elevational view shown;

FIG. 5 is a detail view along line 5-5 in FIG. 2 of shingled solar strips of the solar panel;

FIG. 6 is a front, top, and right side perspective view of a second embodiment of a solar panel;

FIG. 7 is a front elevational view thereof, the rear elevational view forming no part of the claimed design;

FIG. 8 is a top plan view thereof, the bottom plan view being a mirror image of the top plan view shown;

FIG. 9 is a left side elevational view thereof, the right side elevational view being a mirror image of the left side elevational view shown; and,

FIG. 10 is a detail view along line 10-10 in FIG. 7 of shingled solar strips of the solar panel.

The broken lines show portions of the solar panel that form no part of the claimed design.

1 Claim, 6 Drawing Sheets

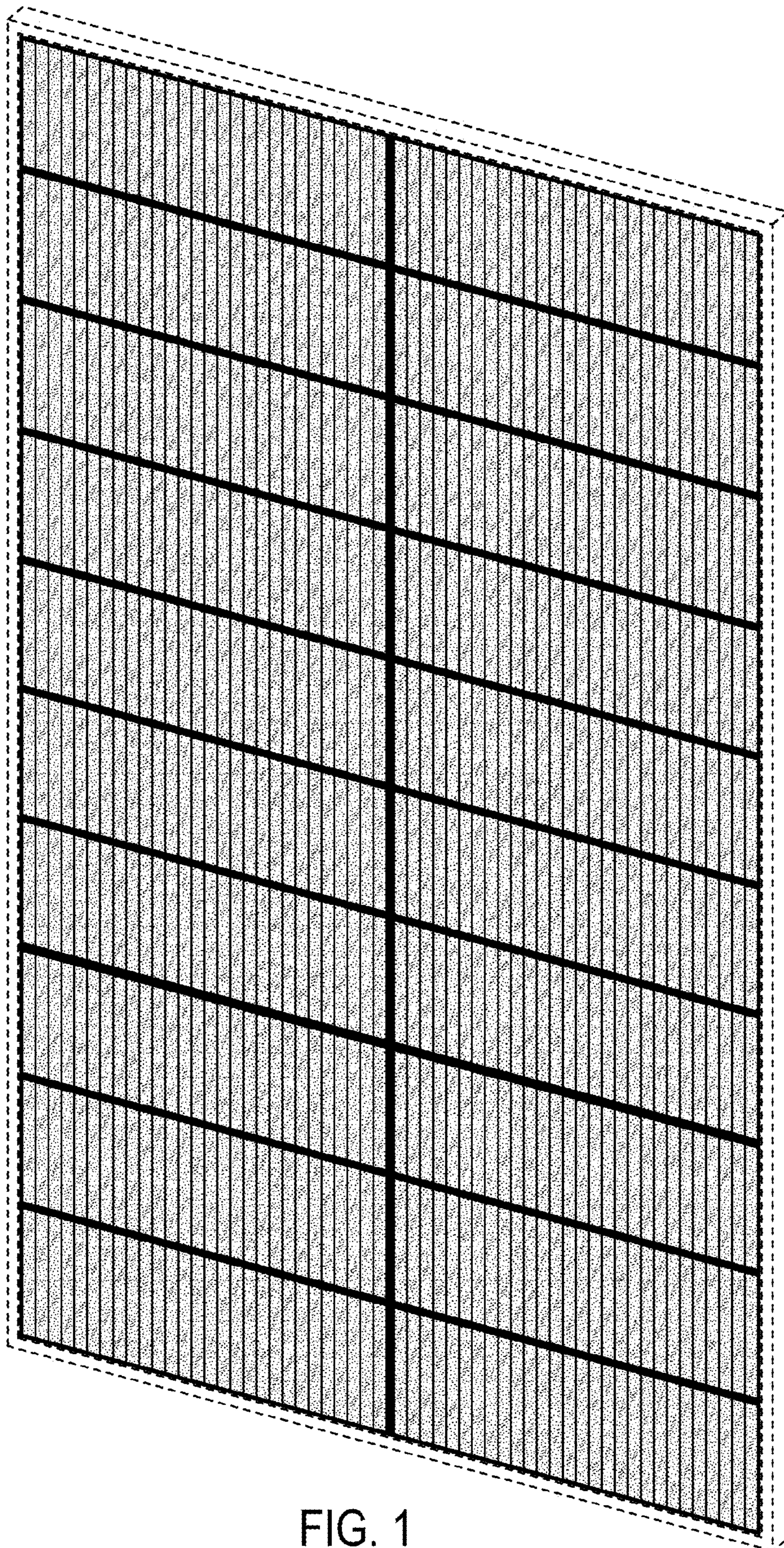


FIG. 1

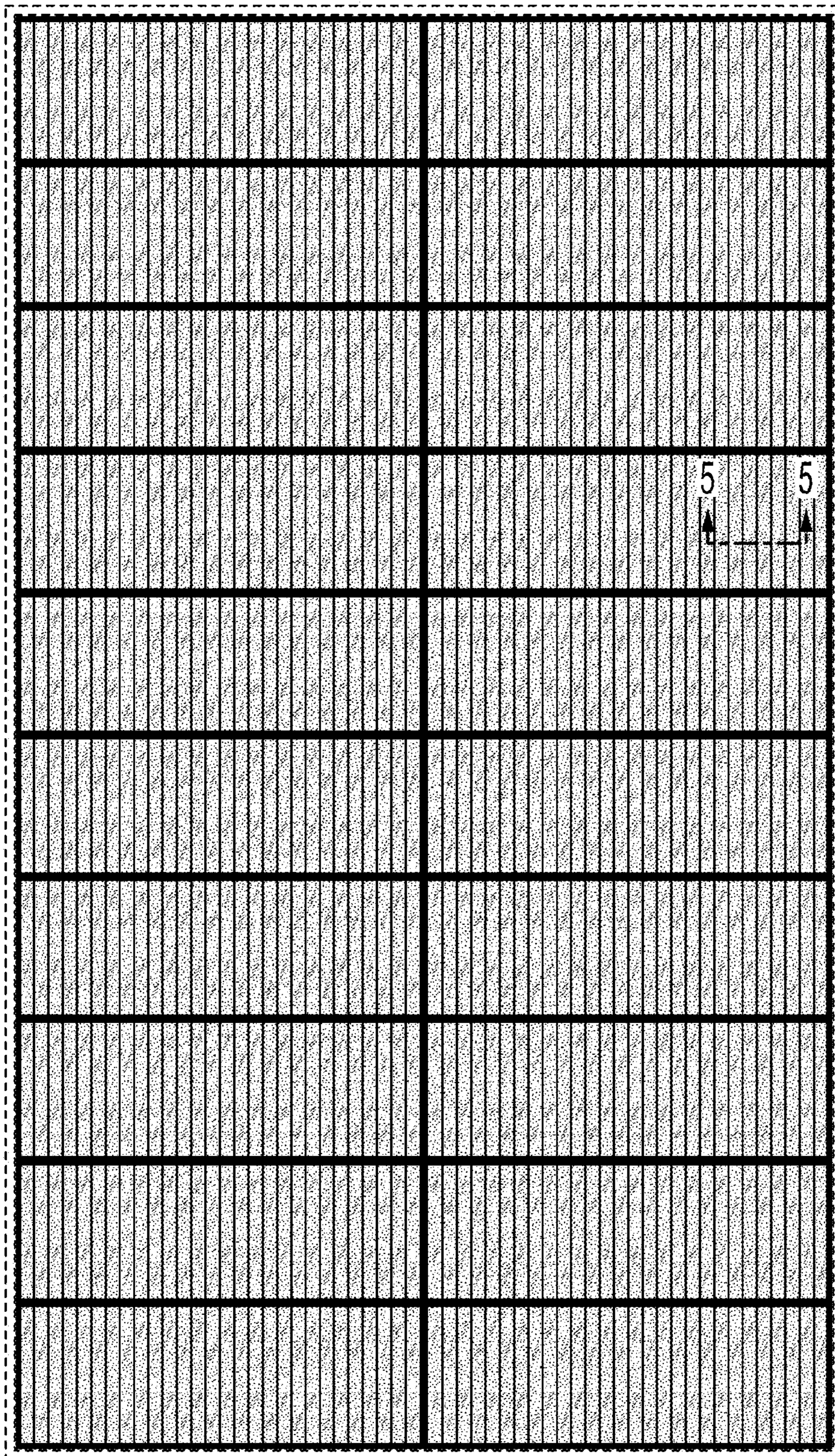


FIG. 2



FIG. 3

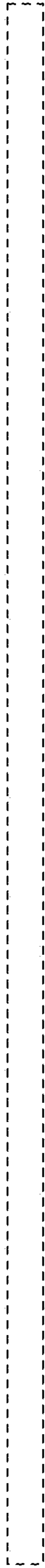


FIG. 4



FIG. 5

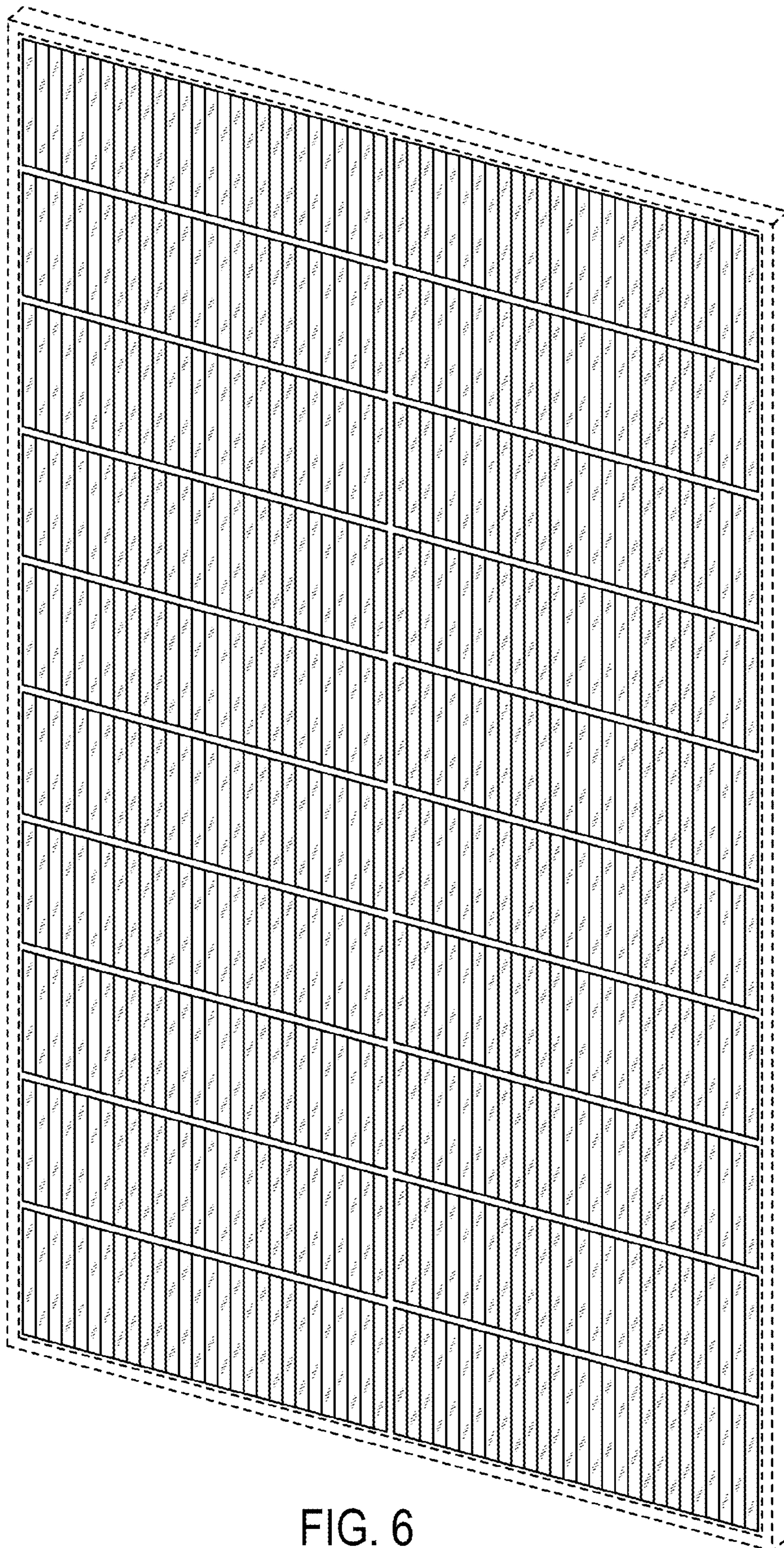


FIG. 6

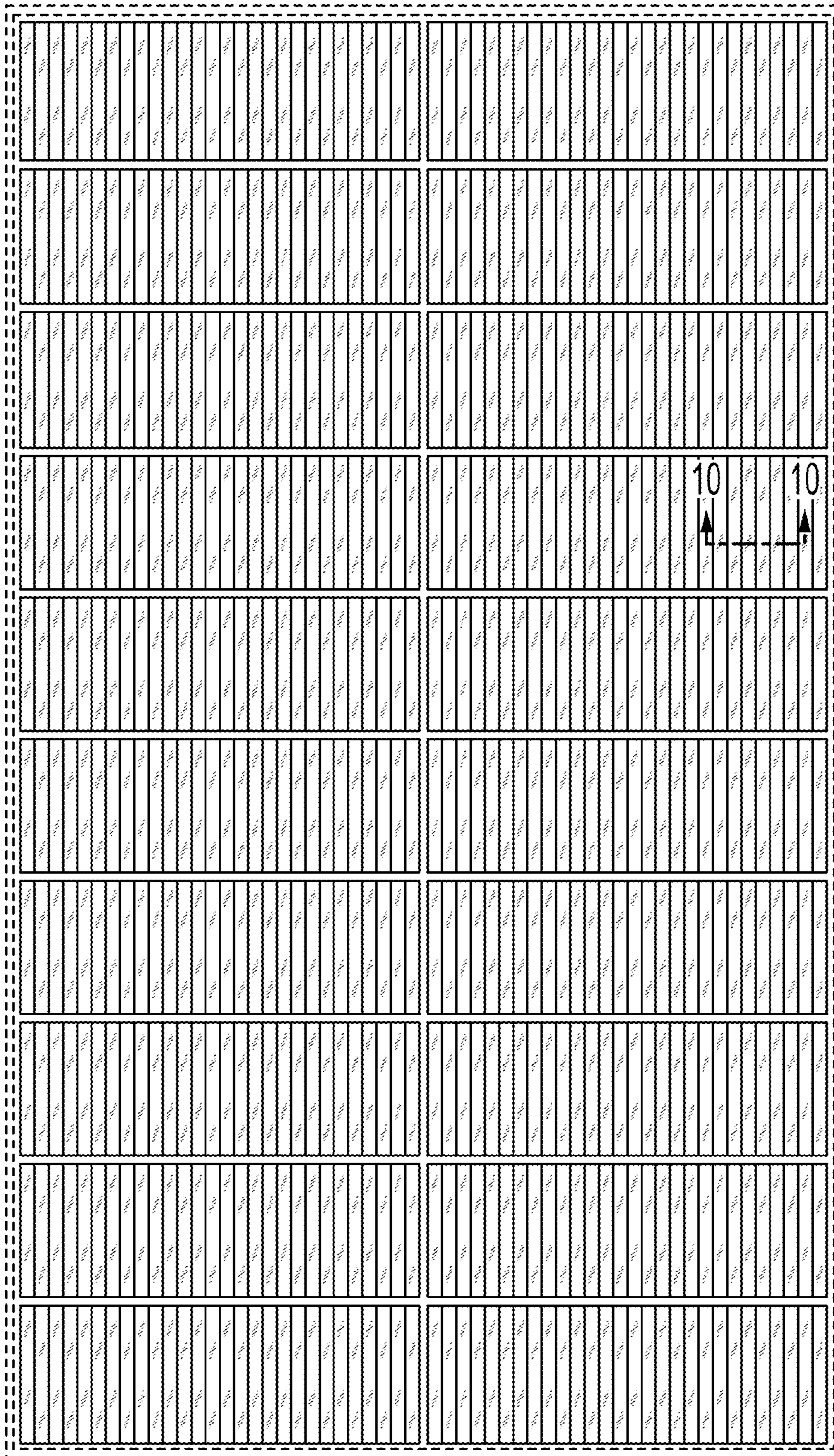


FIG. 7



FIG. 8

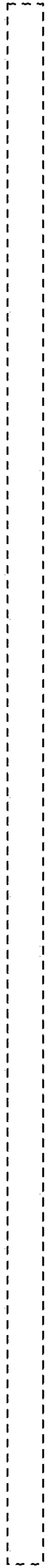


FIG. 9



FIG. 10

UNITED STATES PATENT AND TRADEMARK OFFICE
CERTIFICATE OF CORRECTION

PATENT NO. : D896,747 S
APPLICATION NO. : 29/674623
DATED : September 22, 2020
INVENTOR(S) : Ratson Morad et al.

Page 1 of 2

It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

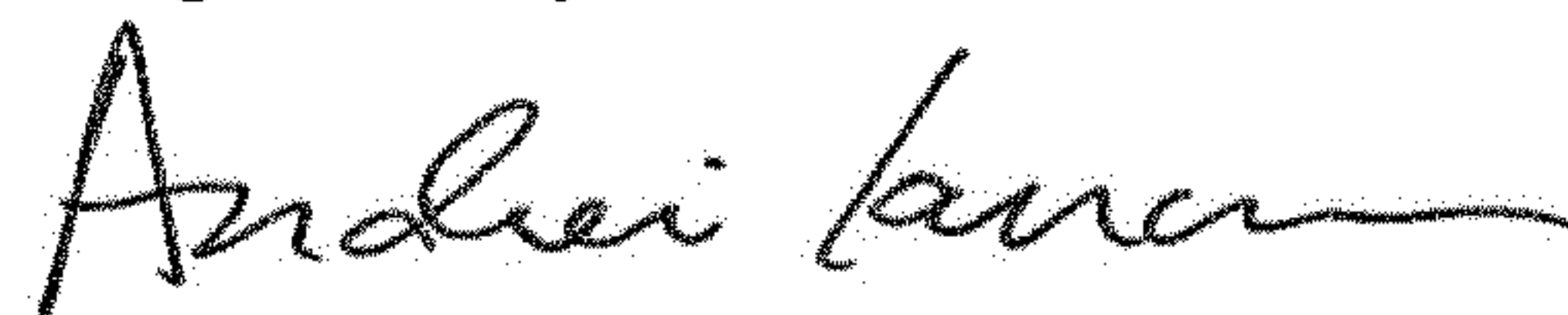
On the Title Page

Item (63), the Related U.S. Application Data information is incorrect. Item (63) should read:

--Related U.S. Application Data

(63) Continuation of Application No. 29/668,612, filed on Oct. 31, 2018, which is a continuation of Application No. 29/617,566, filed on Sep. 14, 2017, which is a continuation of Application No. 15/359,326, filed on Nov. 22, 2016, now Pat. No. 10,090,430, which is a continuation of Application No. PCT/US2015/032472, filed on May 26, 2015, which is a continuation-in-part of Application No. 14/530,405, filed on Oct. 31, 2014, now Pat. No. 9,780,253, and a continuation-in-part of Application No. 14/532,293, filed on Nov. 4, 2014, now abandoned, and a continuation-in-part of Application No. 14/536,486, filed on Nov. 7, 2014, now abandoned, and a continuation-in-part of Application No. 14/539,546, filed on Nov. 12, 2014, now abandoned, and a continuation-in-part of Application No. 14/543,580, filed on Nov. 17, 2014 now Pat. No. 9,882,077 and a continuation-in-part of Application No. 14/548,081, filed on Nov. 19, 2014 now abandoned, and a continuation-in-part of Application No. 14/550,676, filed on Nov. 21, 2014 now abandoned, and a continuation-in-part of Application No. 14/552,761, filed on Nov. 25, 2014, now abandoned, and a continuation-in-part of Application No. 14/560,577, filed on Dec. 4, 2014, now Pat. No. 9,876,132, and a continuation-in-part of Application No. 14/566,278, filed on Dec. 10, 2014, now abandoned, and a continuation-in-part of Application No. 14/565,820, filed on Dec. 10, 2014, now abandoned, and a continuation-in-part of Application No. 14/572,206, filed on Dec. 16, 2014, now Pat. No. 9,401,451, and a continuation-in-part of Application No. 14/577,593, filed on Dec. 19, 2014, now Pat. No. 9,356,184 and a continuation-in-part of Application No. 14/586,025, filed on Dec. 30, 2014, and a continuation-in-part of Application No. 14/585,917, filed on Dec. 30, 2014, now abandoned, and a continuation-in-part of Application No. 14/594,439, filed on Jan. 12, 2015, now Pat. No. 9,397,252 and a continuation-in-part of Application No. 14/605,695, filed on Jan. 26, 2015, now Pat. No. 9,484,484, and a continuation-in-part of Application No. 14/674,983, filed on Mar. 31, 2015, now Pat. No. 9,947,820 and a continuation-in-part of Application No. 29/506,415, filed on Oct. 15, 2014, now abandoned, and a continuation-in-part of Application No. 29/506,755, filed on Oct. 20, 2014, now abandoned, and a continuation-in-part of Application No. 29/508,323, filed on Nov. 5, 2014, now abandoned, and a continuation-in-part of Application No. 29/509,586, filed on Nov. 19, 2014, now Pat. No. Des.

Signed and Sealed this
Eighth Day of December, 2020



Andrei Iancu
Director of the United States Patent and Trademark Office

CERTIFICATE OF CORRECTION (continued)
U.S. Pat. No. D896,747 S

750,556, and a continuation-in-part of Application No. 29/509,588, filed on Nov. 19, 2014, now Pat.
No. Des. 767,484--